



NEWS RELEASE

Credo to Showcase AI Memory and Storage Connectivity Solutions at FMS 2026

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SAN JOSE, Calif.--(BUSINESS WIRE)-- **Credo Technology Group Holding Ltd** (Credo) (NASDAQ: CRDO), an innovator in providing connectivity at scale through fast, reliable, and energy-efficient system solutions, will showcase its latest interconnect products for AI memory and storage applications this week at the FMS (Future of Memory and Storage) 2026 conference. The FMS 2026 conference will take place August 4-6 at the Santa Clara Convention Center.

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"The ability to move data reliably and efficiently across compute, memory, and storage resources is increasingly becoming the

defining factor in AI infrastructure performance," said Vishal Shah, Vice President of Product at Credo. "At Credo, we deliver innovative and reliable connectivity solutions that help overcome memory and storage bottlenecks, enabling systems with higher bandwidth, greater throughput, and more efficiency. We're excited to join industry leaders at the Future of Memory and Storage conference to showcase how these advances are accelerating AI at scale."

Credo Product Highlights (Booth #1146):

- **OmniConnect Weaver solution:** An AI memory and chip-to-chip interconnect that breaks through the memory bottlenecks that limit AI inference scalability. OmniConnect Weaver combines ultra-efficient 112G VSR SerDes with a lightweight AXI framer to deliver up to 25x increase in memory density and 5% increase in bandwidth compared to HBM4.

- **PCIe® 6.0 technology-capable Toucan PCIe retimer:** Extends PCIe reach between CPUs, GPUs, accelerators, and storage enabling greater system design flexibility for next-generation AI infrastructure. Toucan PCIe retimer provides high-performance signal conditioning across challenging channels while also providing structured observability with Credo's PILOT diagnostic and analytics software platform.

Chat with the Experts Event

- Vishal Shah, Vice President of Product, Credo will participate in the **Beer, Pizza & Chat with the Experts event** on Wednesday, August 5 at 7:15 pm on the topic of AI Data Center Storage Architecture / Memory & Storage AI Acceleration.

FMS Best of Show Awards Finalist

- Credo has been named a finalist for the **FMS Best of Show Awards** for its OmniConnect Weaver interconnect solution in two separate award categories: AI Application and User Implementation. The award winners will be announced at the conference on Tuesday, August 4 at 6:00 pm.

To request a meeting or product demo, please contact sales@credosemi.com.

About Credo

Credo's mission is to transform connectivity at scale through fast, reliable, and energy-efficient system solutions. Our high-speed copper and optical interconnect products deliver industry-leading power and performance at up to 1.6T to meet the ever-expanding data infrastructure demands of AI.

Our product portfolio includes ZeroFlap (ZF) Active Electrical Cables (AECs) and ZF optical transceivers, OmniConnect memory solutions, and a suite of retimers and DSPs for optical and copper Ethernet and PCIe, all leveraging the PILOT diagnostic and analytics software platform. Credo innovations enable our customers to connect the systems that connect the world.

For more information, please visit <https://www.credosemi.com>. Follow Credo on **LinkedIn**.

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